Wi-Fi™ / Bluetooth® Modules

Wi-Fi™ + Bluetooth® modules

Type 2EA/2EC

PN: LBEE5XV2EA-802
PN: LBEE5XV2EC-001
CYW55573/CYW55571 Chipset
12.5 x 9.4 x 1.2 mm
FCC/ISED/CE*/Japan Certified

MIMO

802.11 a/b/g/n/ac/ax + Bluetooth® 5

Type 1XA/2BZ

PN: LBEE5XV1XA-540
PN: LBEE5XV2BZ-883
CYW54591/54590 Chipset
11.4 x 8.9 x 1.4 mm
FCC/ISED/CE*/Japan Certified

MIMO

802.11 a/b/g/n/ac + Bluetooth® 5

NEW

Type 2FY/2GY

PN: LBEE5HY2FY-922
PN:LBEE5HY2GY-001
CYW55513/55512 Chipset
7.9 x 7.3 x 1.1 mm
FCC/ISED/CE*/Japan Certified

P2P from Type1MW

802.11 a/b/g/n/ac/ax + Bluetooth® 5
(It only supports 20MHz channel bandwidth)

Type 2AE

PN: LBEE5PK2AE-564
CYW4373 Chipset
8.0 x 7.8 x1.25 mm
FCC/ISED/CE*/Japan Certified

802.11 a/b/g/n/ac + Bluetooth® 5

Type 2GF

PN: LBEE5WV2GF-001
CYW43022 Chipset
10.0 x 7.2 x 1.5 mm
FCC/ISED/CE*/Japan Certified

Low Power

802.11 a/b/g/n/ac + Bluetooth® 5
(It only supports 20MHz channel bandwidth)

Type 1YN

PN: LBEE5KL1YN-814
CYW43439 Chipset
6.95 x 5.15 x 1.1 mm
FCC/ISED/CE*/Japan Certified

P2P from Type1DX

802.11 b/g/n + Bluetooth® 5
(It only supports 20MHz channel bandwidth)

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